

## Thermal Conductivity

### Resin 7501 + Hardener 7920

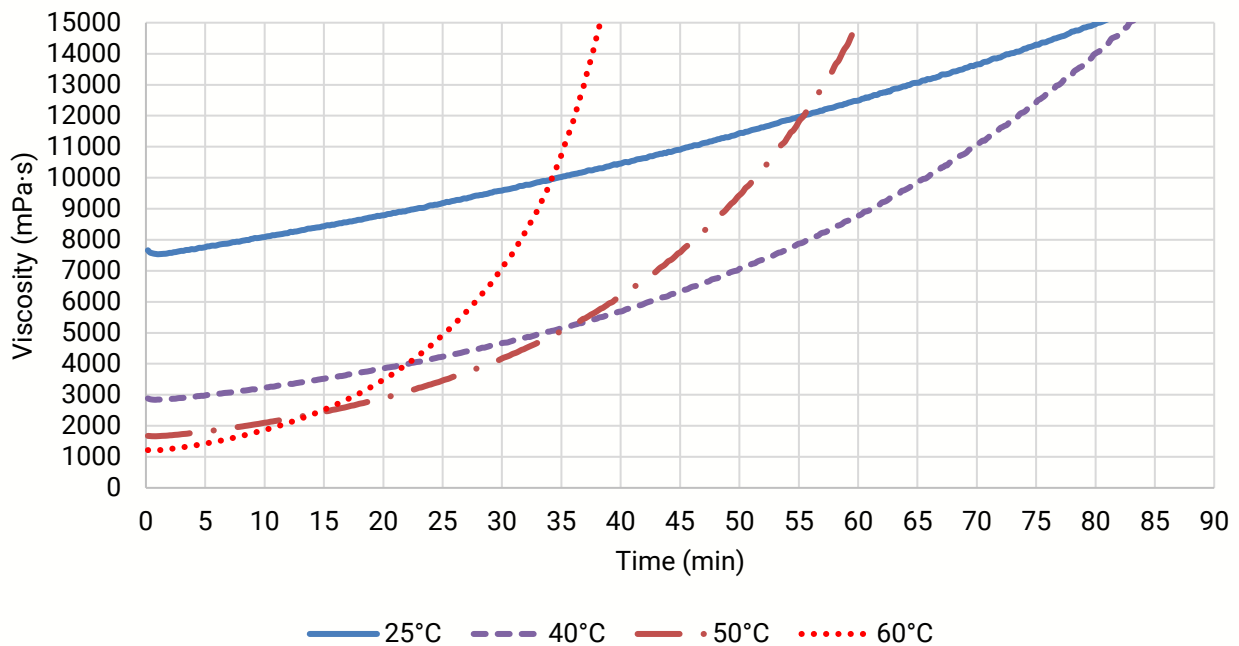
- 2-components epoxy casting resin
- solvent-free system
- no halogenated flame-retardants
- thermal conductivity of 1.2 W/(m·K)
- self-extinguishing properties
- electrically insulating
- high chemical resistance
- ideal for potting of electrical motors and power electronics

#### Product specification:

Mixing ratio (weight):	Resin 7501	100 parts
	Hardener 7920	6.7 parts
Density at 25°C: (DIN EN ISO 2811-1)	Resin 7501	1.85 g/cm <sup>3</sup>
	Hardener 7920	0.95 g/cm <sup>3</sup>
	Mixture	1.75 g/cm <sup>3</sup>
Colour:		Black
Viscosity at 25°C: (Plate/Plate; 10 s <sup>-1</sup> )	Resin 7501	45'000 – 65'000 mPa·s
	Hardener 7920	8 – 12 mPa·s
Mixing viscosity (Plate/Plate; 10 s <sup>-1</sup> )	25°C	7'000 – 8'000 mPa·s
	40°C	2'500 – 3'500 mPa·s
	50°C	1'500 – 2'000 mPa·s
	60°C	1'000 – 1'500 mPa·s
Curing time at 23°C:		48 hours

Pot life: (doubling of viscosity)	25°C	~ 1 hour 20 minutes
	40°C	~ 40 minutes
	50°C	~ 25 minutes
	60°C	~ 15 minutes
Pot life: (Time to reach 15'000 mPa·s)	25°C	~ 1 hour 20 minutes
	40°C	~ 1 hour 25 minutes
	50°C	~ 1 hour
	60°C	~ 40 minutes
Gel time:	25°C	~ 7 hours
	40°C	~ 3 hours 30 minutes
	50°C	~ 2 hours
	60°C	~ 1 hour

Viscosity build-up at various temperatures  
(Plate/Plate; 10 s<sup>-1</sup>)



**Physical properties:**

Shore-Hardness: (DIN EN ISO 868)		D 86
Thermal conductivity:		1.2 W/(m·K)
Glass transition temperature: (DMA half Cp storage modulus)		52°C
Coefficient of expansion: (DMA)	< T <sub>g</sub>	26 ppm/K
	> T <sub>g</sub>	122 ppm/K
Tensile strength (based on DIN EN ISO 527-2)		26 N/mm <sup>2</sup>
Elongation at break (based on DIN EN ISO 527-2)		2.0 %
E-modulus (DIN EN ISO 178)		5'500 N/mm <sup>2</sup>
Flexural strength (DIN EN ISO 178)		61 MPa
Shrinkage after curing:		2.8 %
Operating temperature:		-40°C up to +180°C
Flammability classification: (UL 94)		V-0 in 4.0 mm

**Electrical properties:**

Dielectric strength: (IEC 60243-1)		33 kV/mm
Volume resistance: (IEC 62631-3-1)	23°C / 50% r.H.	7.82·10 <sup>13</sup> Ω·cm
Surface resistance: (IEC 62631-3-1)	23°C / 50% r.H.	3.42·10 <sup>11</sup> Ω
Dielectric constant (ε <sub>r</sub> ) at 23°C: (IEC 62631-2-1)	at 50 Hz	5.5
Dielectric dissipation factor (tan δ): at 23°C (IEC 60250)	at 50 Hz	0.0687
Comparative Tracking Index (CTI): (IEC 60112)		600

Shelf life:	24 months in sealed original containers when stored in dry conditions (15°C to 25°C).
Packaging:	Resin and hardener are offered in separate packaging units.

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